

Electronic Acknowledgement Receipt

EFS ID:	8801192
Application Number:	10814482
International Application Number:	
Confirmation Number:	6082
Title of Invention:	Method for fabricating strained silicon-on-insulator structures and strained silicon-on insulator structures formed thereby
First Named Inventor/Applicant Name:	Toshiharu Furukawa
Customer Number:	30206
Filer:	James R. Nock/Deb Peterson
Filer Authorized By:	James R. Nock
Attorney Docket Number:	ROC920030399US1
Receipt Date:	09-NOV-2010
Filing Date:	31-MAR-2004
Time Stamp:	16:00:37
Application Type:	Utility under 35 USC 111(a)

Payment information:

Submitted with Payment	no
------------------------	----

File Listing:

Document Number	Document Description	File Name	File Size(Bytes)/ Message Digest	Multi Part /.zip	Pages (if appl.)
1	Information Disclosure Statement (IDS) Filed (SB/08)	ROC920030399US1_IDS_11-09-10.pdf	612392 7210d013373b4423adb9c20d848c73419c0232e2	no	4

Warnings:

Information:

A U.S. Patent Number Citation or a U.S. Publication Number Citation is required in the Information Disclosure Statement (IDS) form for autoloading of data into USPTO systems. You may remove the form to add the required data in order to correct the Informational Message if you are citing U.S. References. If you chose not to include U.S. References, the image of the form will be processed and be made available within the Image File Wrapper (IFW) system. However, no data will be extracted from this form. Any additional data such as Foreign Patent Documents or Non Patent Literature will be manually reviewed and keyed into USPTO systems.

2	Foreign Reference	JP01239867A_EnglishAbstract.pdf	574239 7e13a71bddb6ef6cc6b6cd497cd220d2de7c32	no	2
Warnings:					
Information:					
3	Foreign Reference	JP2001144276A_EnglishAbstract.pdf	241593 cc93d16863276a912ee9612f7392d1518e96980	no	1
Warnings:					
Information:					
4	Foreign Reference	JP2003174161A_EnglishAbstract.pdf	168026 01f9d76bb5225a40af4a679c927b63fb26de30d	no	1
Warnings:					
Information:					
5	Foreign Reference	JP2004047806A_EnglishAbstract.pdf	249775 e57269151f78b6d416434e0a739773cf9849bdaa	no	1
Warnings:					
Information:					
6	Foreign Reference	JP2004140274A_EnglishAbstract.pdf	231183 6bc2d40e908e4d5bef1ae031ef8c881a03bd35ea	no	1
Warnings:					
Information:					
7	Foreign Reference	JP2005101234A_EnglishAbstract.pdf	222467 5376d8c0985848f4a225f7813af9e3c56087e54f	no	1
Warnings:					
Information:					
Total Files Size (in bytes):			2299675		

This Acknowledgement Receipt evidences receipt on the noted date by the USPTO of the indicated documents, characterized by the applicant, and including page counts, where applicable. It serves as evidence of receipt similar to a Post Card, as described in MPEP 503.

New Applications Under 35 U.S.C. 111

If a new application is being filed and the application includes the necessary components for a filing date (see 37 CFR 1.53(b)-(d) and MPEP 506), a Filing Receipt (37 CFR 1.54) will be issued in due course and the date shown on this Acknowledgement Receipt will establish the filing date of the application.

National Stage of an International Application under 35 U.S.C. 371

If a timely submission to enter the national stage of an international application is compliant with the conditions of 35 U.S.C. 371 and other applicable requirements a Form PCT/DO/EO/903 indicating acceptance of the application as a national stage submission under 35 U.S.C. 371 will be issued in addition to the Filing Receipt, in due course.

New International Application Filed with the USPTO as a Receiving Office

If a new international application is being filed and the international application includes the necessary components for an international filing date (see PCT Article 11 and MPEP 1810), a Notification of the International Application Number and of the International Filing Date (Form PCT/RO/105) will be issued in due course, subject to prescriptions concerning national security, and the date shown on this Acknowledgement Receipt will establish the international filing date of the application.